502157608 12/11/2012

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Rakesh Jain	12/02/2012
Wenhong Sun	12/03/2012
Jinwei Yang	12/07/2012
Maxim Shatalov	12/03/2012
Alexander Dobrinsky	12/03/2012
Remigijus Gaska	12/05/2012
Michael Shur	12/03/2012

RECEIVING PARTY DATA

Name:	Sensor Electronic Technology, Inc.
Street Address:	1195 Atlas Road
City:	Columbia
State/Country:	SOUTH CAROLINA
Postal Code:	29209

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13692191

CORRESPONDENCE DATA

Fax Number: 5184490047

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 518-449-0044

Email: Icronk@hoffmanwarnick.com
Correspondent Name: Hoffman Warnick LLC
Address Line 1: 540 Broadway

Address Line 2: 4th Floor

Address Line 4: Albany, NEW YORK 12207

ATTORNEY DOCKET NUMBER: SETI-0084

502157608 PATENT REEL: 029442 FRAME: 0947

P \$40.00 13692191

NAME OF SUBMITTER:	John W. LaBatt
Total Attachments: 4 source=SETI-0084_Assignment_allsignature source=SETI-0084_Assignment_allsignature source=SETI-0084_Assignment_allsignature source=SETI-0084_Assignment_allsignature	es#page2.tif es#page3.tif

PATENT REEL: 029442 FRAME: 0948

ASSIGNMENT OF PATENT APPLICATION

FOR GOOD AND VALUABLE CONSIDERATION.

We, the undersigned (each) have agreed and hereby agree to assign for good and valuable consideration, receipt of which is hereby expressly acknowledged, and do hereby sell, assign and transfer unto

Sensor Electronic Technology, Inc.

a corporation organized under the laws of the state of New York as Assignee, and its successors, assigns and legal representatives, the entire right, title and interest, for all countries in and to certain inventions relating to

Epitaxy Technique for Growing Semiconductor Compounds

described in a U.S. Provisional Application No. 61/566,606, filed on 3 December 2011, and in an application for Letters Patent of the United States, identified as Attorney Docket No. SETI-0084, at Hoffman Warnick LLC, 540 Broadway, 4th Floor, Albany, NY 12207, and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part, divisionals, and renewals of and substitutes for either or both of the applications for said Letters Patent, and all the rights and privileges under any and all Letters Patent that may be granted therefor in any country, and any reissues, or reexaminations, or extensions of said Letters Patent. We request that any and all Letters Patent for said inventions be issued to said Assignee, its successors, assigns and legal representatives, or to such nominees as it may designate.

We agree that, when requested, we will, without charge to said Assignee but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for said inventions in any and all countries and for vesting title thereto in said Assignee, its successors, assigns and legal representatives or nominees.

We authorize and empower the Assignee, its successors, assigns and legal representatives or nominees, to invoke and claim for any application for patent or other form of protection for said inventions filed by it or them, the benefit of the right of priority provided by the International Convention for the Protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for it, and to invoke and claim such right of priority without further written or oral authorization from us.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any assignment, consent to file or like document which may be required in any country for any purpose and more particularly in proof of the right of the Assignee or nominee to claim the aforesaid benefit of the right of priority provided by the International convention which may henceforth be substituted for it.

Patent Application Assignment

Page 1 of 2

We covenant with the Assignee, its successors, assigns and legal representatives, that the rights and property herein conveyed are free and clear of any encumbrance, and that we have full right to convey the same as herein expressed.

IN WITNESS WHEREOF, we have hereunto signed our name(s) on the day and year set forth below.

Signature:	Balash Lin	Date: _	12/02/2012
•	Rakesh Jain		
Signature:	Wenhong Sun	Date: _	
Signature:	Jinwei Yang	Date: _	
Signature:	Allow W. Shahili Maxim Shatalov	Date: _	12/03/2012
Signature:	Alexander Dobninsky Alexander Dobrinsky	Date: _	12/03/2012
	Remigijus Gaska	Date: _	
Signature:	Michael Shur	Date:	12/03/2012

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Page 1 of 2

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IN WITNESS WHEREOF, we have hereunto signed our name(s) on the day and year set forth below.

Signature:	Rakesh Jain	Date: _	W
Signature:	Wedneson Wenhong Sun	Date: _	Dec.3,2012
Signatur t. ;	Jinwei Yang	Date: _	12/7/2012
Signature:	Maxim Shatalov	Date: _	
Signature:	Alexander Dobrinsky	Date: _	
Signature:,	Remigijus Gaska	Date: _	12/05/2012
Signature:	Michael Shur	Date:_	

Patent Application Assignment

RECORDED: 12/11/2012

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